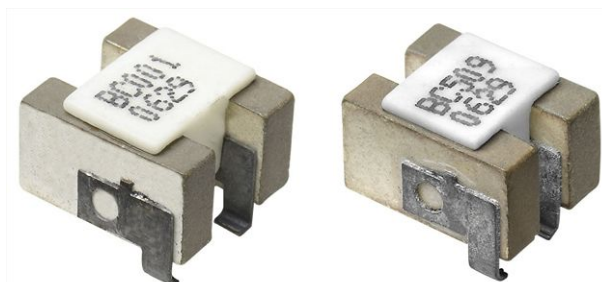


TWIN Vertical SMD PTC Thermistors For Telecom Overload Protection



QUICK REFERENCE DATA

PARAMETER	VALUE	UNIT
Resistance value at 25 °C	10 to 50	Ω
Switching temperature	105 to 130	°C
Maximum voltage (RMS)	240	V _{RMS}
Maximum overload current	2.5 to 8.0	A
Operating temperature range at V _{max}	-40 to 85	°C
Maximum trip time at 1 A	1.2 to 4.0	s
Weight	~ 1.3	g

DESCRIPTION

The component consists of two high performance PTC ceramics mounted together on an alumina spacer cover and with 4 lead (Pb)-free tin plated contacts. The terminations are joined to the Ag plated ceramics by a high melting solder.

MARKING

- All TWIN Vertical SMD PTC's are marked with the last 3-digits of the type number (BCxxx) and a date code (YYWW)

FEATURES

- Very small footprint, allowing to increase the number of lines per PCB
- Matched pairs in one component, significantly reducing the assembly time
- Narrow tracking between the 2 PTC's over a wide temperature range (matching at 85 °C: $\leq 2 \times$ matching at 25 °C)
- Limited height and weight, used on high speed pick-and-place circuit assembly
- Flat pick-up ceramic area for easy placement
- Small ceramics for faster response time
- Thermal coupled PTC's for enhanced protection
- Small and large pitch available
- Compliant with the enhanced level requirements of ITU - K20-21-45 edition 2003
- Suitable for lead (Pb)-bearing and lead (Pb)-free reflow soldering
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

APPLICATIONS

Over-temperature/over-load protection:

- Telecom
 - Telecommunications infrastructure
 - PABX
 - Set-top Box (S.B.)

MOUNTING

A flat pick-up area of 30 mm² and low weight allows for fast placement. No excessive solder paste should be used as no solder or flux can reach the ceramic body during reflow soldering. Not suitable for bismuth containing solder.

Typical soldering

235 °C, duration: 5 s (Lead (Pb)-bearing)

245 °C, duration: 5 s (Lead (Pb)-free)

Resistance to soldering heat

260 °C, duration: 10 s max.

ELECTRICAL DATA

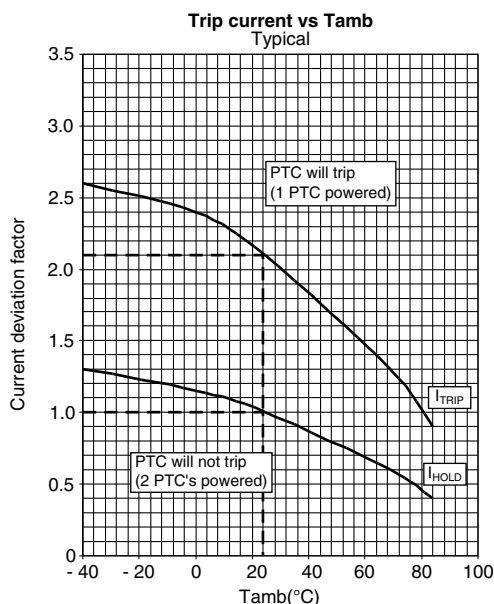
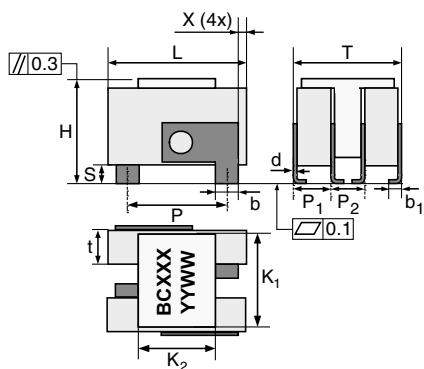
R_{25} $\pm 20\%$ (Ω)	MATCHING (Ω)	V _{max.} (V _{RMS})	I _{nt} at			I _t (mA)	MAX. TRIP-TIME at 1 A (s)	I _{max.} at V _{max.} (A)	I _{res} (2 PIECES POWERED) at V _{max.} (mA)
			25 °C (mA)	70 °C (mA)	85 °C (mA)				
10	0.5	240	140	85	55	300	4.0	4.0	12.0
20	0.5	240	90	60	40	200	2.0	8.0	12.0
25	0.5	240	100	60	40	200	2.0	4.0	12.0
35	1.0	240	100	60	40	200	1.5	4.0	12.0
50	1.0	240	90	50	35	190	1.2	2.5	12.0

Note

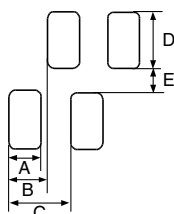
- All data is measured at 25 °C unless otherwise specified

ORDERING INFORMATION

$R_{25} \pm 20\%$ (Ω)	SAP CODING	
	SMALL PITCH	LARGE PITCH
10	PTCTT95R100GTE	PTCTT95R100GTELAR
20	PTCTT95R200GTE	PTCTT95R200GTELAR
25	PTCTT95R250GTE	PTCTT95R250GTELAR
35	PTCTT95R350GTE	PTCTT95R350GTELAR
50	PTCTT95R500GTE	PTCTT95R500GTELAR

ELECTRICAL CHARACTERISTICS

PTC OUTLINES

DIMENSIONS in millimeters

	SMALL PITCH	LARGE PITCH
L	9.0 ± 0.1	9.0 ± 0.1
T	7.2 ± 0.25	8.4 ± 0.25
H	6.9 ± 0.25	6.9 ± 0.25
b	1.5 ± 0.1	1.5 ± 0.1
b ₁	0.9 ± 0.15	0.9 ± 0.15
S	1.25 ± 0.15	1.25 ± 0.15
d	0.22 ± 0.025	0.22 ± 0.025
t	2.3 ± 0.1	2.3 ± 0.1
P	6.5 ± 0.5	6.5 ± 0.5
P ₁	2.55 ± 0.15	2.55 ± 0.15
P ₂	2.2 ± 0.1	3.45 ± 0.15
X	0.5 ± 0.2	0.5 ± 0.2
K ₁	6.0 ± 0.5	7.2 ± 0.5
K ₂	5.0 ± 0.5	5.0 ± 0.5

FOOTPRINT

RECOMMENDED FOOTPRINT in millimeters

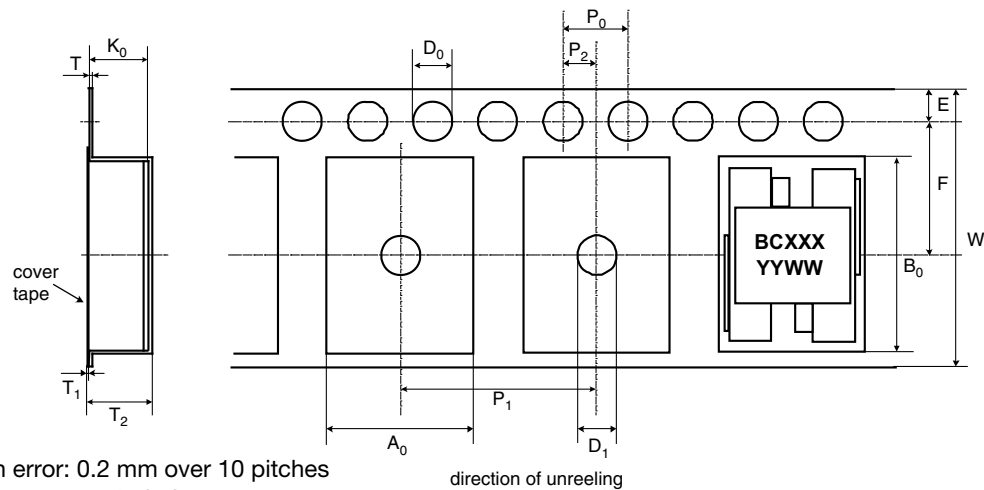
	SMALL PITCH	LARGE PITCH
A	2.0	2.0
B	2.4	2.4
C	3.8	5.0
D	3.8	4.0
E	2.7	1.4

PACKAGING

Tape specifications

All tape and reel specifications are in accordance with IEC 60286-3. Carrier tape material is non-conductive polystyrene or polycarbonate.

Blister tape



Cumulative pitch error: 0.2 mm over 10 pitches

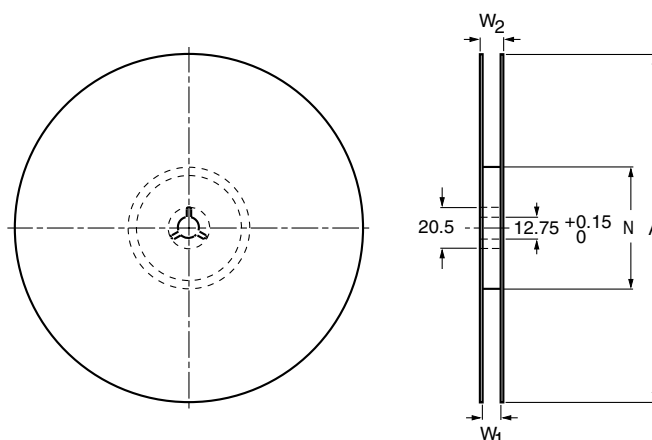
Cumulative tolerance over 10 holes: ± 0.2 mm

DIMENSIONS OF BLISTER TAPE in millimeters

	SMALL PITCH	LARGE PITCH		SMALL PITCH	LARGE PITCH
A_0	7.2 ± 0.1	8.4 ± 0.1	D_1	1.5 ± 0.1	1.5 ± 0.1
B_0	9.3 ± 0.1	9.3 ± 0.1	P_0	4.0 ± 0.1	4.0 ± 0.1
K_0	7.2 ± 0.1	7.2 ± 0.1	P_1	12.0 ± 0.1	12.0 ± 0.1
W	16.0 ± 0.3	16.0 ± 0.3	P_2	2.0 ± 0.1	2.0 ± 0.1
E	1.75 ± 0.1	1.75 ± 0.1	T	0.5 ± 0.05	0.5 ± 0.05
F	7.5 ± 0.1	7.5 ± 0.1	T_1	0.05	0.05
D_0	1.5 ± 0.1	1.5 ± 0.1	T_2	7.8 max.	7.8 max.

REEL SPECIFICATIONS in millimeters

Reel



REEL DIMENSIONS in millimeters

UNITS PER REEL	TAPE WIDTH	A	N	W_1	W_2 MAX.
1000	16	380	64	16.4	20.4

Note

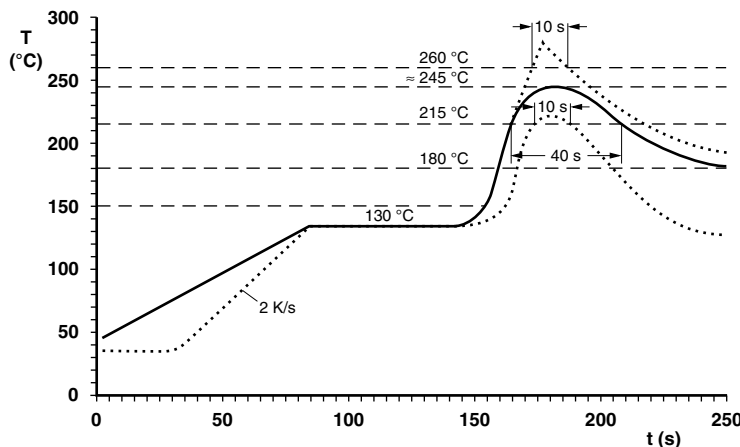
- Reels are packed in sealed plastic bags for protection against high humidity and corrosive atmospheres

SOLDERING CONDITIONS

This SMD thermistor is only suitable for reflow soldering, in accordance with JEDEC J-STD-020. Soldering processes which can be used are reflow (infrared and convection heating) and vapour phase. The maximum temperature of 260 °C during 10 s should not be exceeded and no liquid flux should be allowed to reach the ceramic body.

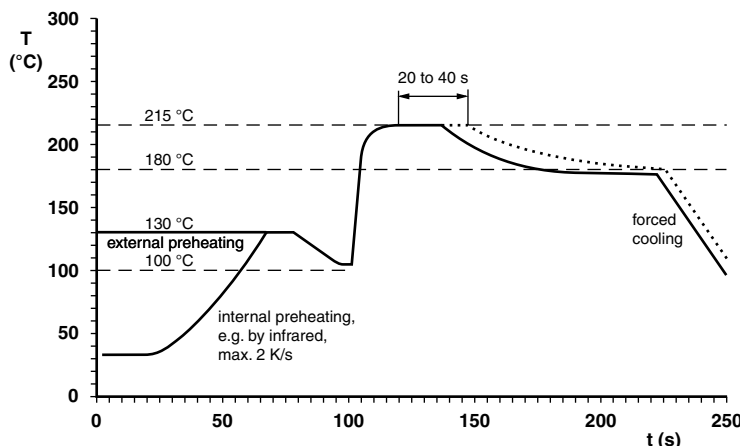
Typical examples of soldering processes that will provide reliable joints without damage, are shown below.

Reflow soldering



Typical values (solid line)
Process limits (dotted lines)

Vapour phase soldering



Typical values (solid line)
Process limits (dotted line)

HANDLING PRECAUTIONS

Because of the nature of PTC ceramic material the component should not be touched with bare hands, as the residue of perspiration can influence component behaviour at high temperatures.

Handling forces applied to the component should be limited to 5 N in any condition.



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